

# **Specification for Approval**

### Date: 2021/08/16

Customer :	天诚科技	
TAI-TECH P/N:	TMPA0402SP-2R2MN	

CUSTOMER P/N:

**DESCRIPTION:** 

QUANTITY:

REMARK:	
	Customer Approval Foodback
	Customer Approval Feedback
	西北臺慶科技股份有限公司
	TAI-TECH Advanced Electronics Co., Ltd

	115			
- 1	T	十里	闷	٠

■ 深圳市天诚科技有限公司 Shenzhen TsaSun Technology Co., Ltd. Room 209, 2/F, Block A, Tengfei Industrial Building, No.6, Taohua Road, Futian District, Shenzhen TEL: 0755-8335 8885 / 0755-8335 9885 E-mail: sales@tsasun.com www.tsacoil.com

APPROVED	CHECKED
夏暁曼	夏暁曼

□ 西北臺慶科技股份有限公司
TAI-TECH Advanced Electronics Co., Ltd
<u>Headquarter:</u>
NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI,
TAO-YUAN HSIEN, TAIWAN, R.O.C.
TEL: +886-3-4641148 FAX: +886-3-4643565
http://www.tai-tech.com.tw
E-mail: sales@tai-tech.com.tw

□ 臺慶精密電子(昆山)有限公司 TAI-TECH ADVANCED ELECTRONICS(KUNSHAN)CO., LTD SHINWHA ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA TEL: +86-512-57619396 FAX: +86-512-57619688 E-mail: hui@tai-tech.com.tw

#### **R&D** Center

Sales Dep.

APPROVED	CHECKED	DRAWN
羅宜春	梁周虎	卜文娟

### **SMD** Power Inductor

#### 1. Features

- 1. Shielded construction.
- 2. Capable of corresponding high frequency .
- 3. Low loss realized with low DCR.
- 4. High performance (Isat) realized by metal dust core.
- 5. Ultra low buzz noise, due to composite construction.
- 6. 100% Lead(Pb)-Free and RoHS compliant.

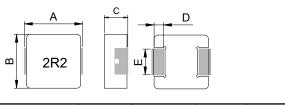
### 2. Applications

- 1. DC/DC converters in distributed power systems.
- 2. DC/DC converter for Field Programmable Gate Array(FPGA).
- 3. Battery powered devices.
- 4. Thin type on-board power supply module for exchanger.

5. VRM for server.

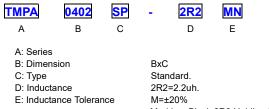
- 6. High current, low profile POL converters.
- 7. PDA/notebook/desktop/server and battery powered devices.

### 3. Dimensions



Series	Α	в	С	D	Е
TMPA0402SP	4.45±0.25	4.10±0.20	1.8±0.2	0.8±0.25	2.0±0.20
Unit:mm					

### 4. Part Numbering



Marking: Black.2R2 Unidirectional printing.

### 5. Specification

Part Number	Inductance L0 A(uH) ±20%	Heat Rating Current DC ( A ) Irms.		Saturation Current DC (A)I sat		DCR (mΩ)Typ	DCR (mΩ)Max
	120 /0	Тур	Max	Тур	Max		
TMPA0402SP-2R2MN	2.20	5.5	5.0	4.5	4.0	41	48

Note:

- 2. All test data referenced to  $25^\circ\!\mathbb{C}$  ambient.
- 3. Testing Instrument(or equ) : L: HP4284A,CH11025,CH3302,CH1320,CH1320,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER.
- 4. Heat Rated Current (Irms) will cause the coil temperature rise approximately  $~\Delta T$  of 40  $^\circ C$
- 5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
- 6. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

 $\mathcal{M}$ 

7. Special inquiries besides the above common used types can be met on your requirement.

Halogen-free

TMPA0402SP-2R2MN

-		-	
1111		1111	-
			т
		V//D	
	G		

**Recommend PC Board Pattern** 

L(mm)	G(mm)	H(mm)		
5.2	2.2	2.5		
Note: 1. The above DCP leveut reference only				

te: 1. The above PCB layout reference only.
2. Recommend solder paste thickness at
0.12mm and above

0.12mm and above.

<sup>1.</sup> Test frequency : Ls : 100KHz /1.0V.

### 6. Material List

Marking	NO	Items	Materials
	1	Core	Alloy Powder .
	2	Wire	Polyester Wire or equivalent.
	3	Clip	100% Pb free solder(Ni+SnPlating)
	4	Ink	Halogen-free ketone
1 2 3	L		·

### 7. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	110~+40°C,50~60%RH (Product without taping) 240~+125℃ (on board)	
Electrical Performance 1	Test	
Inductance		HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR	Refer to standard electrical characteristics list.	CH16502, Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately △L30%.	Saturation DC Current (Isat) will cause L0 to drop $\triangle L(\%)$
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise △T(℃). 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDECJ-STD-020DClassification Reflow Profiles) Temperature : 125±2°(Inductor) Applied current : rated current Duration : 1000±12hrs Measured at room temperature after placing for 24±2 hrs.
Load Humidity		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Humidity : 85±2% R.H, Temperature : 85°C±2°C Duration : 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs.
Moisture Resistance	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDECJ-STD-020DClassification Reflow Profiles) 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to $65\pm2°C$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to $25°C$ in 2.5hrs. 3. Raise temperature to $65\pm2°C$ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to $25°C$ in 2.5hrs,keep at $25°C$ for 2 hrs then keep at $-10°C$ for 3 hrs 4. Keep at $25°C$ 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		$\label{eq:preconditioning: Run through IR reflow for 2 times.( IPC/JEDECJ-STD-020DClassification Reflow Profiles) Condition for 1 cycle Step1: -40 \pm 2 \mathbb{C} 30 \pm 5 \mathbb{N} Step2: 25 \pm 2 \mathbb{C} \leqq 0.5 \mathbb{N} Step3: 125 \pm 2 \mathbb{C} \implies 30 \pm 5 \mathbb{N} Measured at room femprature after placing for 24 \pm 2 hrs.$
Vibration		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) °

#### TAI-TECH

Item	Performance	Test Condition			
Bending	Appearance ∶ No damage. Impedance ∶ within±15% of initial value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.			
Shock	Inductance : within 13% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Type     Peak value (g's)     Normal duration (D) (ms)     Wave form     Velocity change (Vi)ft/sec			
Chock		SMD     50     11     Half-sine     11.3       Lead     50     11     Half-sine     11.3			
Solder ability	More than 95% of the terminal electrode should be covered with solder 。	Preheat: 150°C,60sec. ∘ Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination			
Resistance to Soldering Heat		Depth: completely cover the termination   Temperature(°C)   Time(s)   Temperature ramp/immersion and emersion rate   260 ±5			
Terminal Strength	Inductance : within±10% of initial value	200 L3   10 ±1   25mm/s ±6 mm/s   1     Preconditioning: Run through IR reflow for 2 times.( IPC/JEDE J-STD-020DClassification Reflow Profiles   With the component mounted on a PCB with the device to 1 tested, apply a force(>0805:1kg, <=0805:0.5kg)to the side of device being tested. This force shall be applied gradually as not apply a shock to the component being tested.			

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.

#### 8. Soldering and Mounting

#### (1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### (2) Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

#### (3) Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

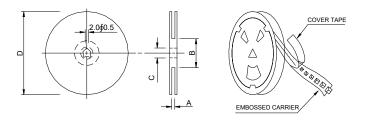
- Preheat circuit and products to 150°C
   • Never contact the ceramic with the iron tip
  355°C tip temperature (max)
  1.0mm tip diameter (max)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
  Limit soldering time to 4~5sec.
- Reflow Soldering Iron Soldering PRE-HEATING SOLDERING NATURAL PRE-HEATING SOLDERING NATURAL within 4~5s TP(260℃ / 10s max. 350 TEMPERATURE(¢₿) tp(245¢&/20~40s.) remperature(¢®) 217 60~150s 150 200 60~180s Gradual cooling Over 60s 480s ma: TIME(sec.) TIME(sec.) Iron Soldering times: 1 times max. Reflow times: 3 times max. Fig.1 Fig.2

#### 9. Friendly reminder

- (1) When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product.

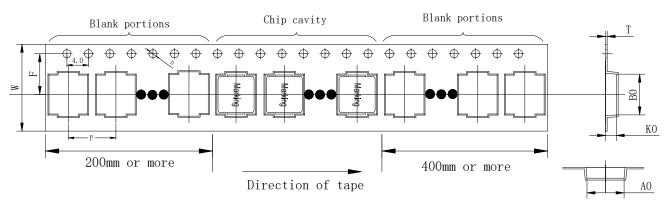
### 10. Packaging Information

#### (1) Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
13"x12mm	12.4+2/-0	100±2	13+0.5/-0.2	330

#### (2) Tape Dimension

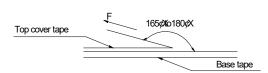


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)
ТМРА	0402	5.0±0.1	4.40±0.1	2.3±0.1	8.0±0.1	12±0.3	5.5±0.1	0.35±0.05	1.5±0.1

#### (3) Packaging Quantity

ТМРА	0402		
Chip / Reel	3000		
Inner box	6000		
Carton	24000		

#### (4) Tearing Off Force



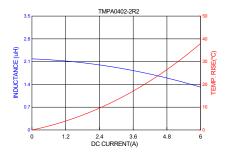
The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 stadnard).

Room Temp.	Room Humidity	Room atm	Tearing Speed
(℃)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

#### Application Notice

- Storage Conditions
  - To maintain the solderability of terminal electrodes:
  - 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
  - 2. Temperature and humidity conditions: Less than  $40^{\circ}$ C and  $60^{\circ}$ RH.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
  - 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

### 11. Typical Performance Curves



## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by Tai-Tech manufacturer:

Other Similar products are found below :

 CR32NP-151KC
 CR32NP-180KC
 CR32NP-181KC
 CR32NP-1R5MC
 CR32NP-390KC
 CR32NP-680KC
 CR54NP-680KC
 <th